LB1846MC

ON Semiconductor®

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Bi-CMOS integrated circuit

5V Low Saturation Voltage Drive
Stepper Motor Driver
Application Note

Overview

The LB1846MC is a 1-channel low saturation voltage stepper motor driver IC. It is optimal for motor drive in 5V system products and it can drive a stepping motor in Full-step and Half-step.
Also LB1846MC is suitable for use with gas burner for its latch valve drive. The latch valve functions as a safety device to prevent gas leakage.

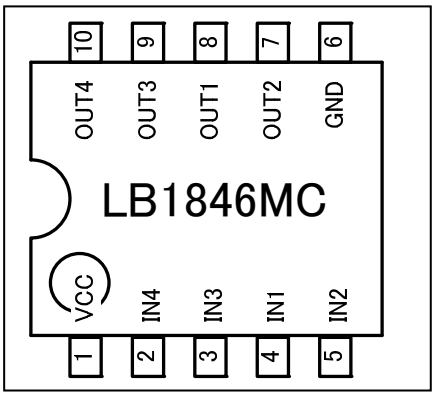
Function

- BIP output transistor adoption (Upper and lower total Vo(sat)=0.55V(typical) at Io=400mA)
- For one power supply (The control system power supply is unnecessary.)
- Our motor driver IC, LB1973JA, and compatible functions
- It is possible to connect it in parallel (parallel, connected operation of drive ch).
- The compact package (MFP10SK) is adopted.
- V_{CC} max = 8v, I_O max = 0.8A
- Current consumption 0 when standing by
- Built-in Thermal protection function

Typical Applications

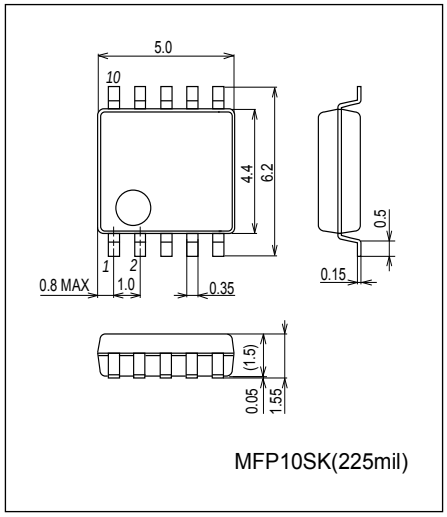
- Printer
- Security camera
- Label Printer
- Gas table
- POS Printer / terminal
- Document scanner

Pin Assignment



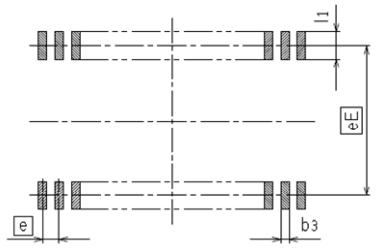
Package Dimensions

unit : mm (typ)



Caution: The package dimension is a reference value, which is not a guaranteed value.

Recommended Soldering Footprint



(Unit:mm)

Reference Symbol	MFP10SK(225mil)
eE	5.60
e	1.00
b3	0.47
l1	1.00

Block Diagram

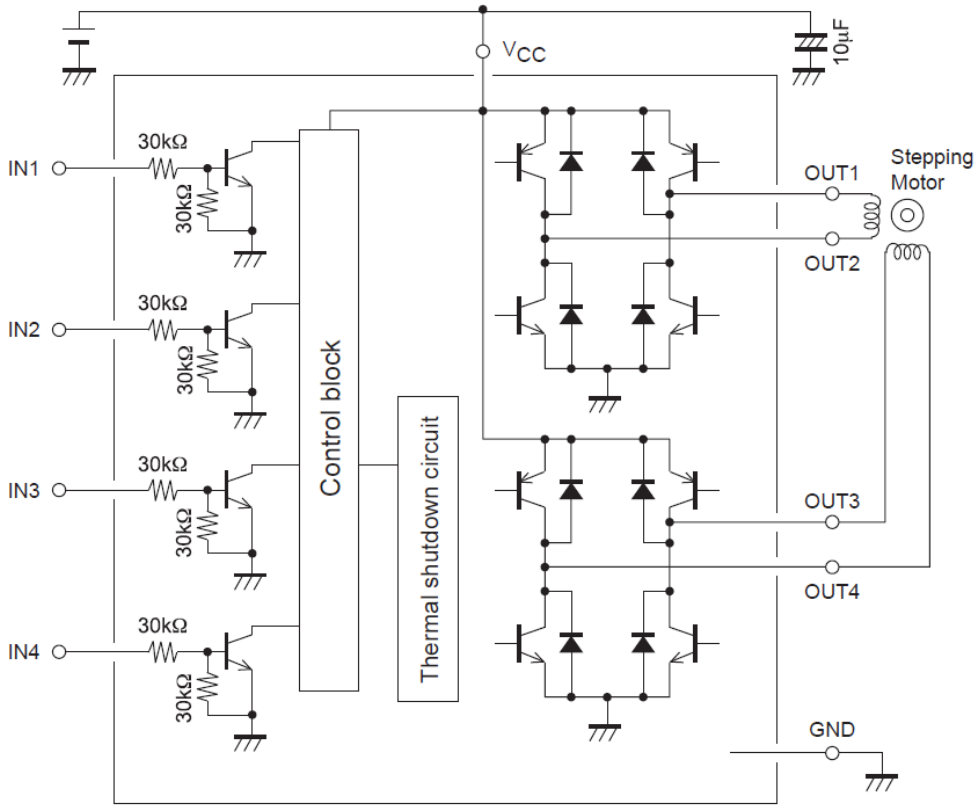


Figure1 One stepping motor drive

Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V_{CC} max		-0.3 to +8.0	V
Output voltage	V_{OUT}		V_{CC} + V_{SF}	V
Input voltage	V_{IN}		-0.3 to +8.0	V
Ground pin outflow current	I_{GND}	Per channel	800	mA
Allowable power dissipation	Pd max	When mounted*	870	mW
Operating temperature	Topr		-20 to +75	°C
Storage temperature	Tstg		-40 to +150	°C

*1: When mounted on the specified printed circuit board (114.3mm × 76.2mm × 1.5mm), glass epoxy board

Caution 1) Absolute maximum ratings represent the value which cannot be exceeded for any length of time.

Caution 2) Even when the device is used within the range of absolute maximum ratings, as a result of continuous usage under high temperature, high current, high voltage, or drastic temperature change, the reliability of the IC may be degraded. Please contact us for the further details.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

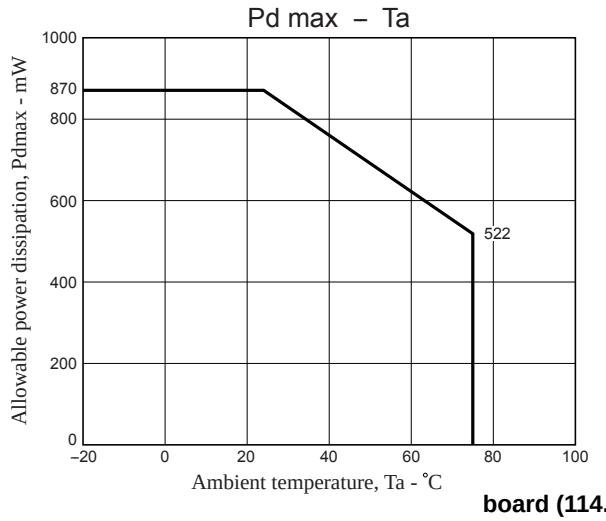
Recommended Operating Conditions at Ta = 25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Supply voltage	V_{CC}		2.5		7.5	V
Input high-level voltage	V_{IH}		2.5		7.5	V
Input low-level voltage	V_{IL}		-0.3		+0.7	V

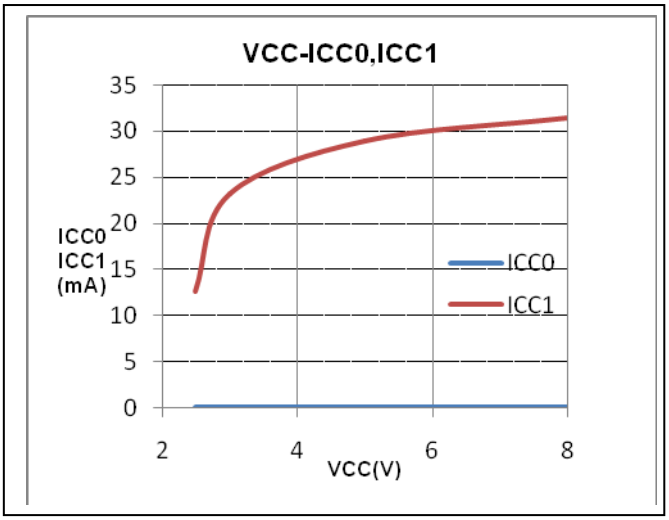
Electrical Characteristics at Ta = 25°C, V_{CC} = 5V

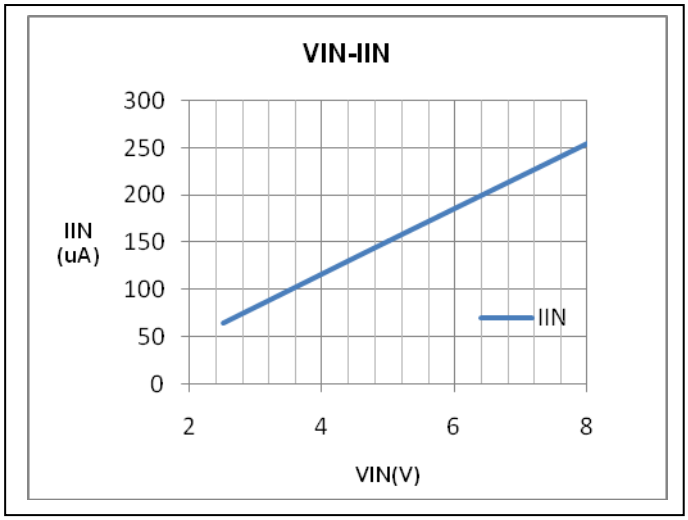
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Current drain	$I_{CC}0$	IN1, 2, 3, 4 = 0V		0.1	10	μA
	$I_{CC}1$	IN1, 3 = 3V, IN2, 4 = 0V		30	40	mA
Output saturation voltage	$V_{OUT}1$	V_{IN} = 3V or 0V, V_{CC} = 3 to 7.5V, I_{OUT} = 200mA		0.27	0.4	V
	$V_{OUT}2$	V_{IN} = 3V or 0V, V_{CC} = 4 to 7.5V, I_{OUT} = 400mA		0.55	0.8	V
Input current	I_{IN}	V_{IN} = 5V		150	200	μA
Spark Killer Diode						
Reverse current	I_S (leak)				30	μA
Forward voltage	V_{SF}	I_{OUT} = 400mA			1.7	V

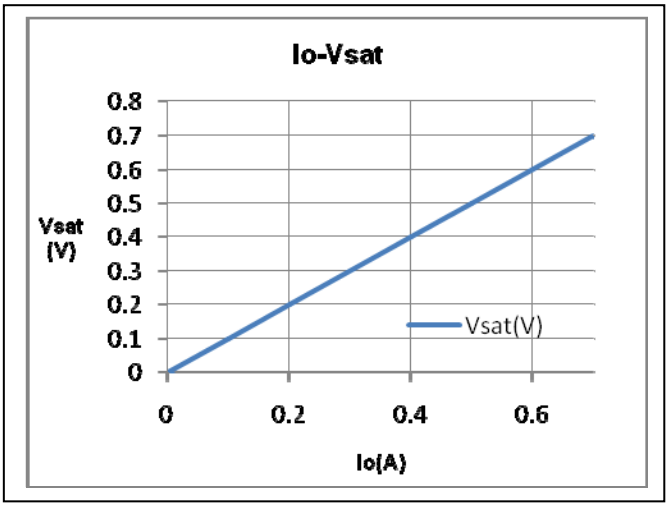
Pdmax

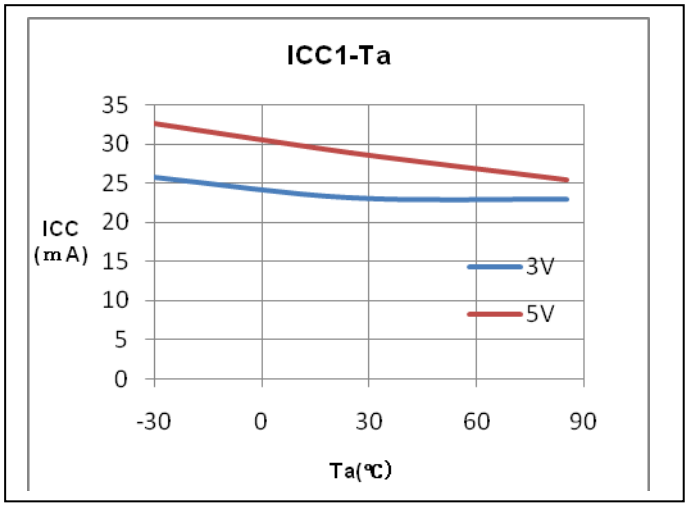


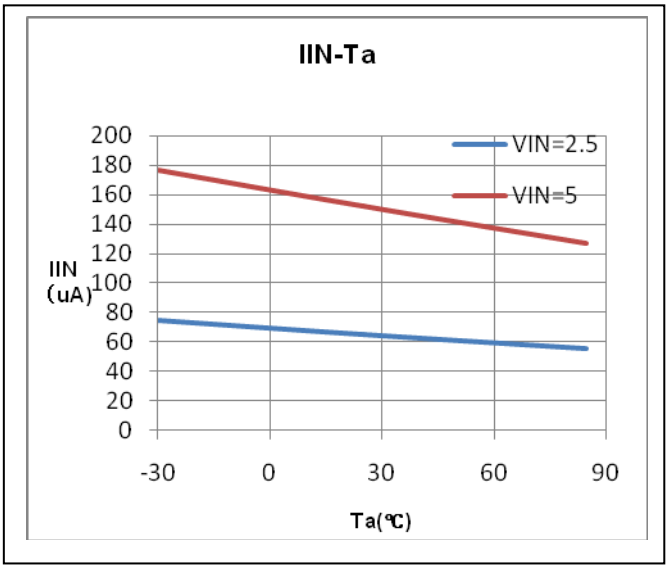
board (114.3mm × 76.2mm × 1.5mm), glass epoxy board

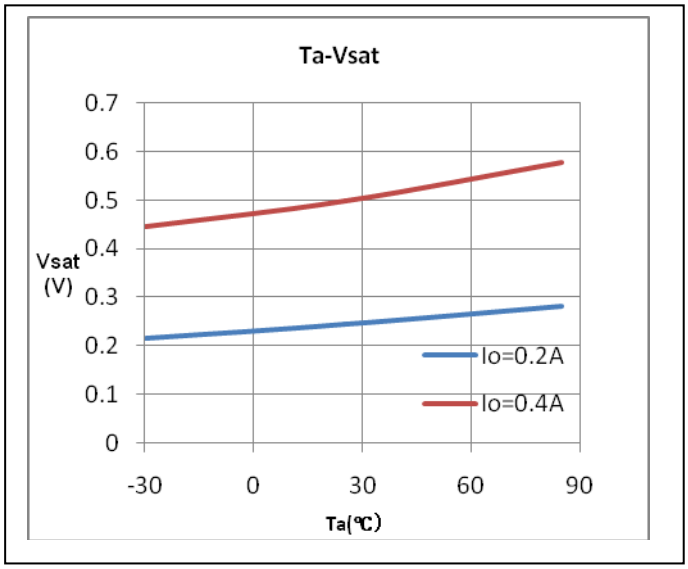

VCC-ICC0,ICC1
ICC0
ICC1
(mA)
VCC(V)
ICC0
ICC1


VIN-IIN
IIN
(uA)
VIN(V)
IIN

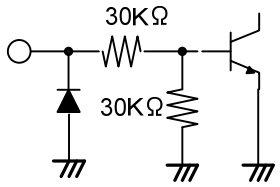
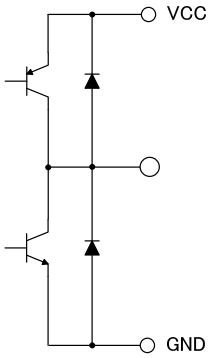

Io-Vsat
Vsat
(V)
Io(A)
Vsat(V)


ICC1-Ta
ICC
(mA)
Ta(℃)
3V
5V


IIN-Ta
IIN
(uA)
Ta(℃)
VIN=2.5
VIN=5


Ta-Vsat
Vsat
(V)
Ta(℃)
Io=0.2A
Io=0.4A

Pin function

Pin No.	Pin name	Pin function	Equivalent Circuit
1	V_{CC}	Power-supply voltage pin. V_{CC} voltage is impressed. The permissible operation voltage is from 2.5 to 7.5(V). The capacitor is connected for stabilization for GND pin (6pin).	
4	IN1	Motor drive control input pin. Driving control input pin of OUT1 (8pin) and OUT2 (7pin). It combines with IN2 pin (5pin) and it fights desperately. The digital input it, range of the "L" level input is 0 to 0.7(V), range of the "H" level input is from2.5 to 7.5(V). Pull-down resistance 30(kΩ) is built into in the pin. It becomes a standby mode because all IN1, IN2, IN3, and IN4 pins are made "L", and the circuit current can be adjusted to 0.	
5	IN2	Motor drive control input pin. Driving control input pin of OUT1 (8pin) and OUT2 (7pin). It combines with IN1 pin (4pin) and it uses it. With built-in pull-down resistance.	
3	IN3	Motor drive control input pin. Driving control input pin of OUT3 (9pin) and OUT4 (10pin). It combines with IN4 pin (2pin) and it uses it. With built-in pull-down resistance.	
2	IN4	Motor drive control input pin. Driving control input pin of OUT3 (9pin) and OUT4 (10pin). It combines with IN3 pin (3pin) and it uses it. With built-in pull-down resistance.	
6	GND	Ground pin.	
10	OUT4	Driving output pin. The motor coil is connected between terminal OUT3 (9pin).	
9	OUT3	Driving output pin. The motor coil is connected between terminal OUT4 (10pin).	
7	OUT2	Driving output pin. The motor coil is connected between terminal OUT1 (8pin).	
8	OUT1	Driving output pin. The motor coil is connected between terminal OUT2 (7pin).	

Operation explanation

1. Output control logic

IN1	IN2	IN3	IN4	OUT1	OUT2	OUT3	OUT4	Note
L	L	L	L	OFF	OFF	OFF	OFF	Standby
H	L	L	L	H	L	OFF	OFF	1-2 phase excitation
H	L	H	L	H	L	H	L	
L	L	H	L	OFF	OFF	H	L	
L	H	H	L	L	H	H	L	
L	H	L	L	L	H	OFF	OFF	
L	H	L	H	L	H	L	H	
L	L	L	H	OFF	OFF	L	H	
H	L	L	H	H	L	L	H	
H	H	-	-	The logic output for the first high-level input is produced. *2				
-	-	H	H					

Note: *1 "-" indicates a "don't care" input.

*2 If two high levels (H/H) are input to the IN1/IN2 pins with the timing shown in (1) in the figure below, then the IN2 input that arrived later will be ignored and the IC will function as though an H/L combination is applied to the IN1/IN2 pins. Similarly, the timing shown in (2) results in a L/H combination on the IN1/IN2 pins.

2. Thermal shutdown function

The thermal shutdown circuit is incorporated and the output is turned off when junction temperature Tj exceeds 200°C. As the temperature falls by hysteresis, the output turned on again (automatic restoration). The thermal shutdown circuit does not guarantee the protection of the final product because it operates when the temperature exceed the junction temperature of Tjmax=150°C.

TSD = 180°C (typ)

ΔTSD = 20°C (typ)

(1) Thermal shutdown temperature

The thermal shutdown temperature Ttsd is 180±20°C with fluctuations.

(2) Thermal shutdown operation

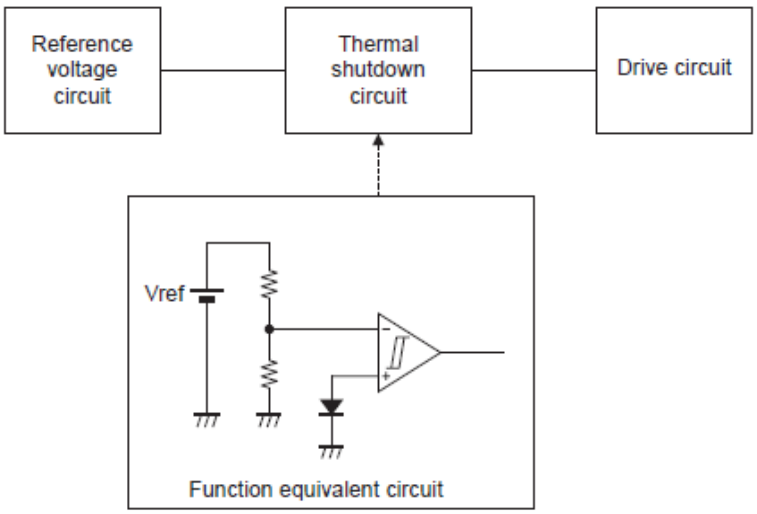
The operation of the thermal shutdown circuit is shown in the figure below.

When the chip temperature Tj is in the direction of increasing (solid line), the output turns off at approximately 180°C.

When the chip temperature Tj is in the direction of decreasing (dotted line), the output turns on (returns) at approximately 160°C.

(Thermal shutdown circuit block diagram)

The thermal shutdown circuit compares the voltage of the heat sensitive element (diode) with the reference voltage and shuts off the drive circuit at a certain temperature to protect the IC chip from overheating.

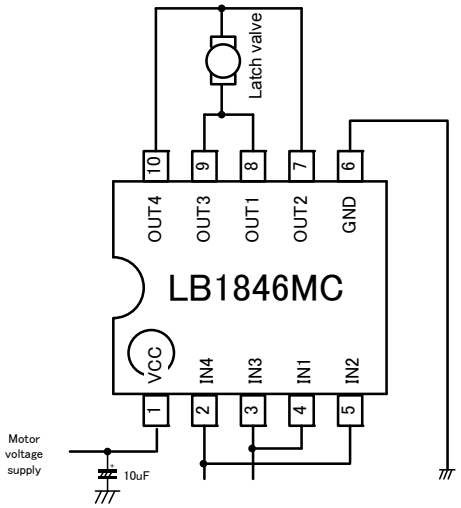


Note: The above is an example of thermal shutdown circuits although ther are same differences from the actual internal circuit.

Design Documentation

(1) Voltage magnitude relationship
There are no restrictions on the magnitude relationships between the voltage applied to Vcc and IN1 to IN4.

(2) Parallel connection
The LB1846MC can be used as a single-channel H-bridge power supply by connecting IN1 to IN3, IN2 to IN4, OUT1 to OUT3, and OUT2 to OUT4 as shown in the figure.
(Iomax=1.6A, Vo(sat)=0.6V(typical) at Io=800mA)



(3) Observe the following points when designing the printed circuit board pattern layout.
- Make the Vcc and ground lines as wide and as short as possible to lower the wiring inductance.
- Insert bypass capacitors between Vcc and ground mounted as close as possible to the IC.
- Resistors of about 10KΩ must be inserted between the CPU output ports and the IN1 to IN4 pins if the microcontroller and the LB1846MC are mounted on different printed circuit boards and the ground potentials differ significantly.

Operation principal

- Full-Step Drive
  Motor advances 90 degree by inputting 1 step.

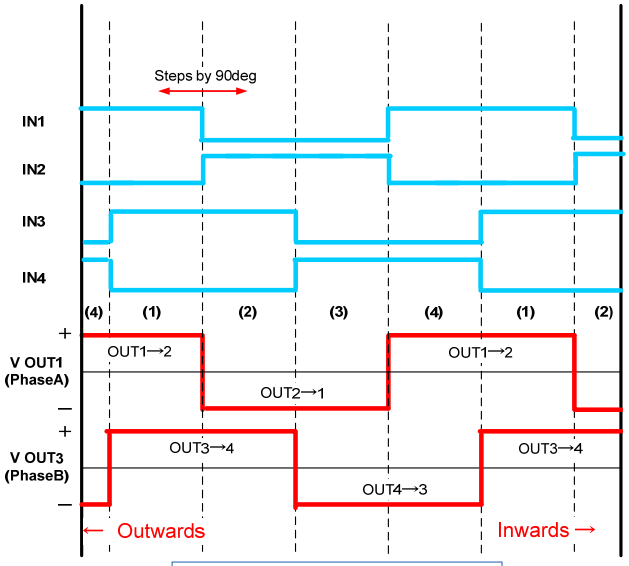


Figure 1. Full-Step Timing

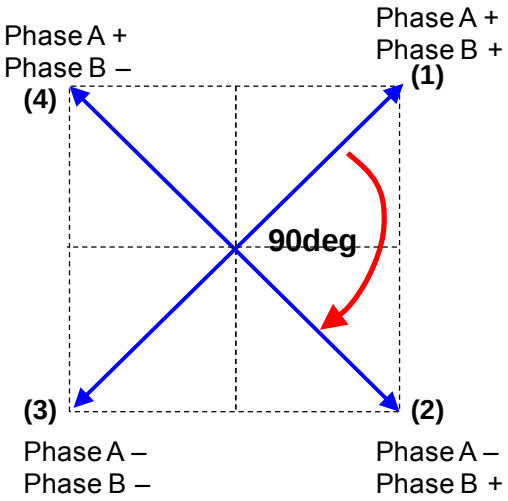


Figure 2. Motor electric angle
(Full Step Drive)

- Half-Step Drive
  Motor advances 45 degree by inputting 1 step.

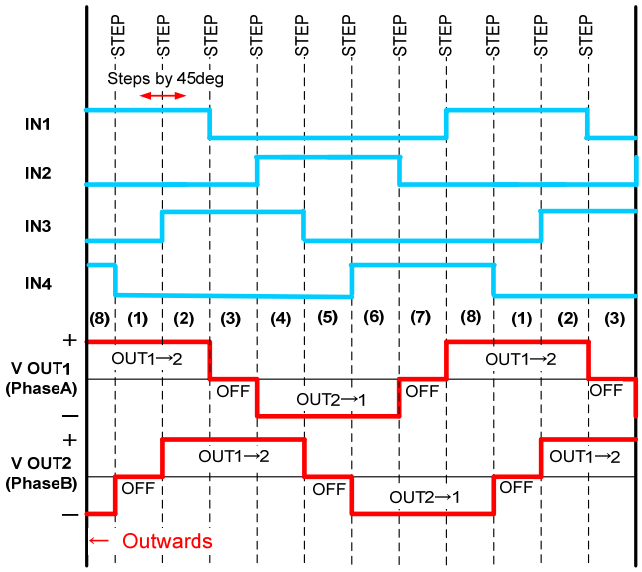


Figure 3. Half-Step Timing

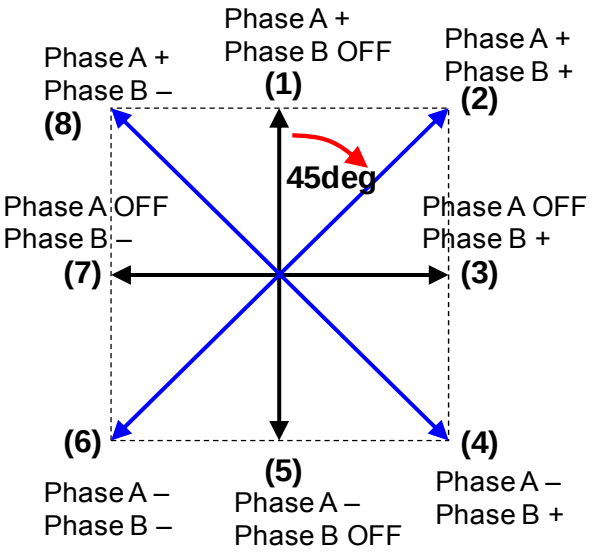


Figure 4. Motor electric angle
(Half Step Drive)

- Latch valve operation sequence
  The following diagram shows the example of latch valve sequence from Standby, Forward, Reverse, Forward, and Reverse.
  When IN1, IN2, IN3, IN4 are "L", the operation of LB1973JA is stopped.
  Please put standby mode for 10usec between Forward and Reverse.

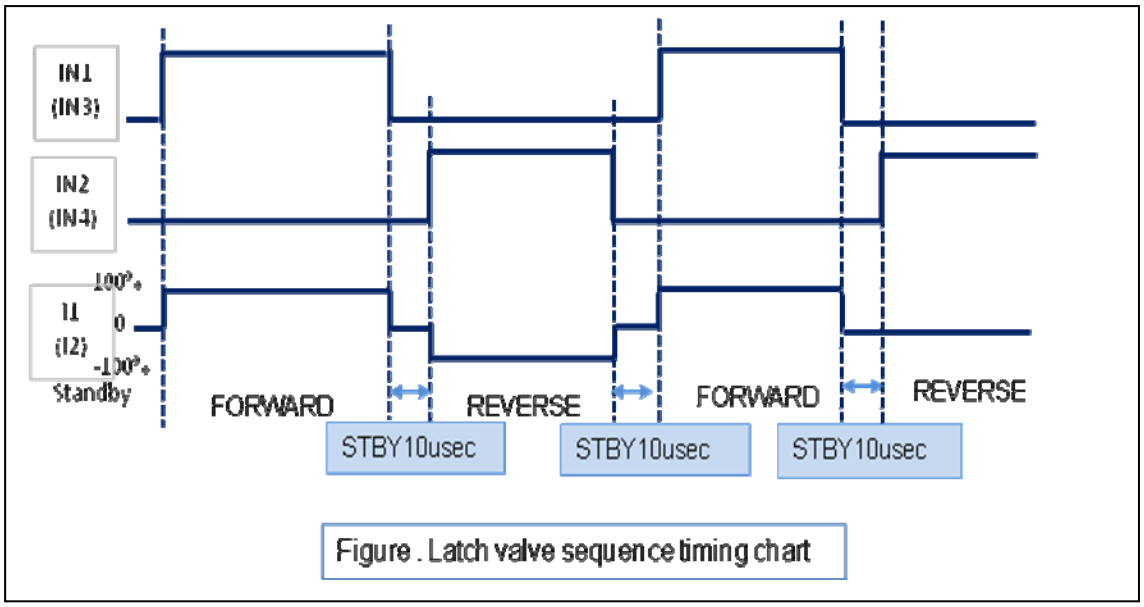
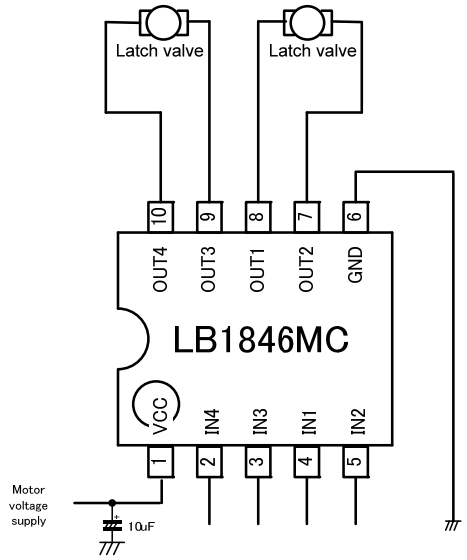


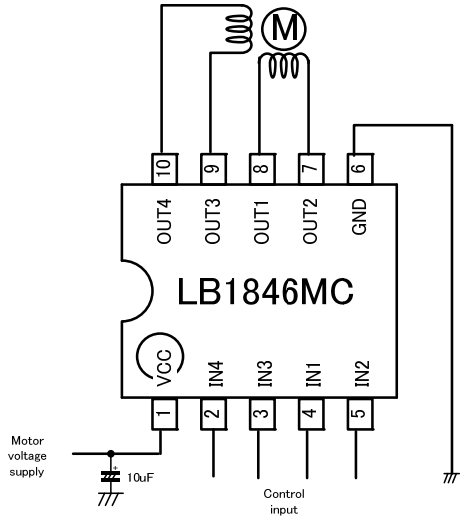
Figure . Latch valve sequence timing chart

Application Circuit Example

1. Example of applied circuit when two Latch valve driving

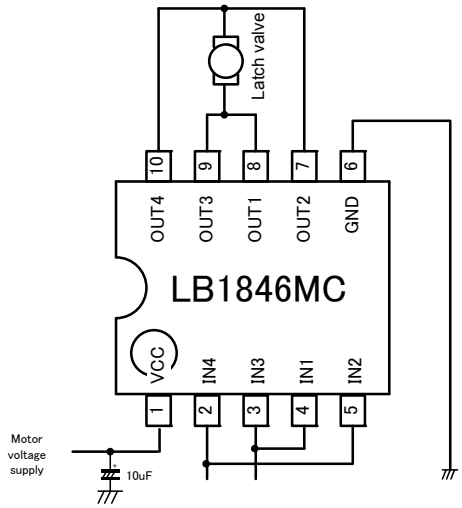


2. Example of applied circuit when one stepping motor driving



3. Example of applied circuit when connecting it in parallel

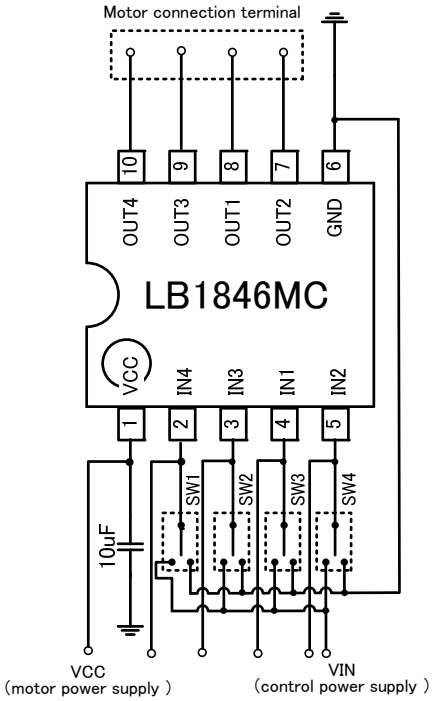
   The use likened to H-Bridge 1ch is shown possible in the figure below by connecting IN1 with IN3, IN2 with IN4, OUT1 with OUT3, and OUT2 with OUT4. (I_O max = 1.6A, Upper and lower total Vo(sat)=0.275V(typ) at Io=800mA)



* Bypass capacitor (C1) connected between V_{CC}-GND of all examples of applied circuit recommends the electric field capacitor of 0.1μA to 10μA.
Confirm there is no problem in operation in the state of the motor load including the temperature property about the value of the capacitor.
Mount the position where the capacitor is mounted on nearest IC.

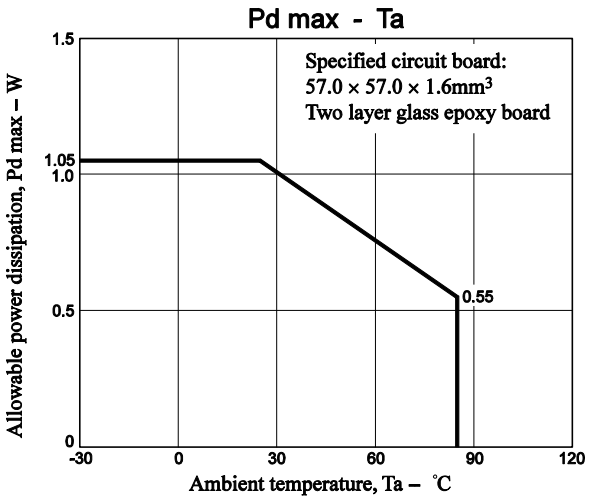
Evaluation Board Manual

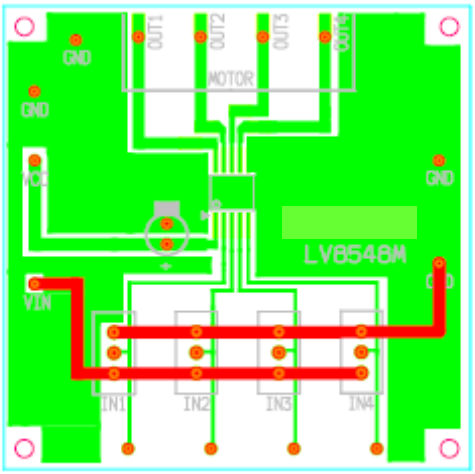
1. Evaluation Board circuit diagram



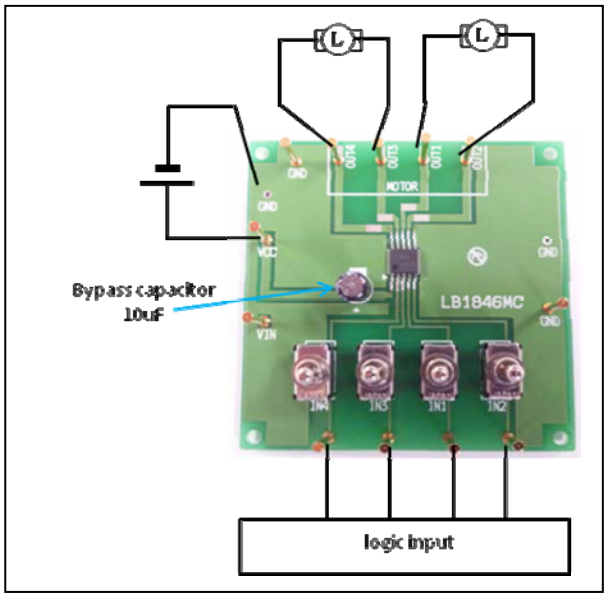
Bill of Materials for LB1948MC Evaluation Board

Designator	Qty	Description	Value	Tol	Footprint	Manufacturer	Manufacturer Part Number	Substitution Allowed	Lead Free
IC1	1	Motor Driver			MFP10SK (225mil)	ON semiconductor	LB1846MC	No	Yes
C1	1	VCC Bypass capacitor	10μF 50V	±20%		SUN Electronic Industries	50ME10HC	Yes	Yes
SW1-SW4	4	Switch				MIYAMA	MS-621-A01	Yes	Yes
TP1-TP12	12	Test points				MAC8	ST-1-3	Yes	Yes





2. Two Latch valve drive



- Connect OUT1 and OUT2, OUT3 and OUT4 to a Latch valve each.
- Connect the motor power supply with the terminal VCC, the control power supply with the terminal VIN. Connect the GND line with the terminal GND.
- DC motor becomes the predetermined output state corresponding to the input state by inputting a signal such as the following truth value table into IN1~IN4.
- See the table in p.6 for further information on input logic.

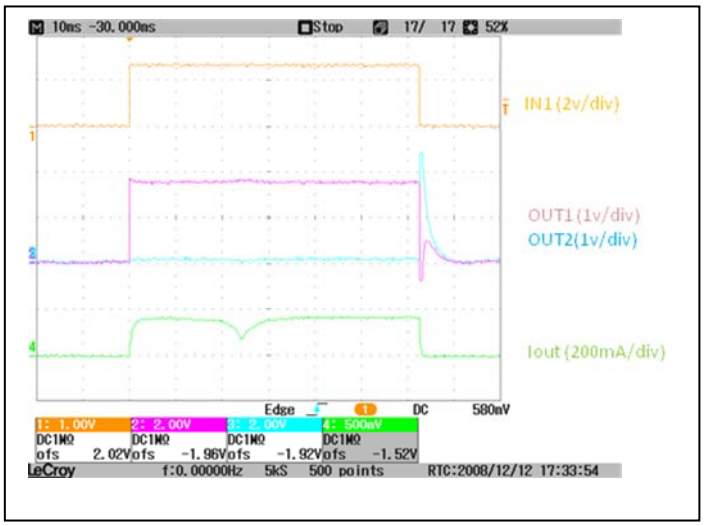
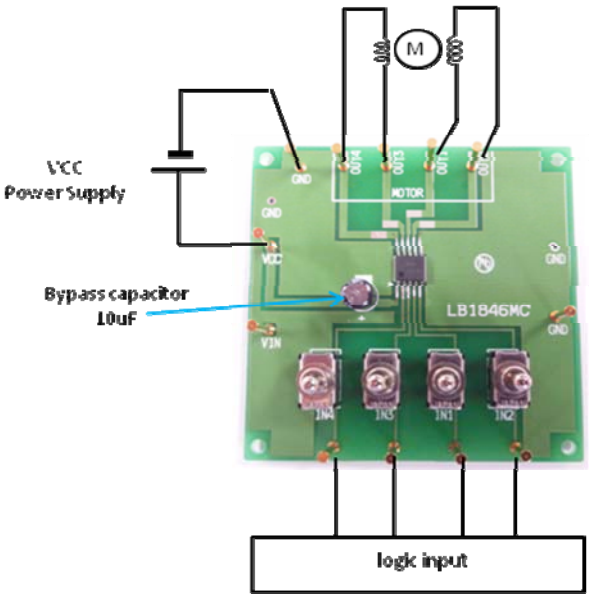


Figure # Latch valve waveform (VCC=2V)

3. One stepping motor drive

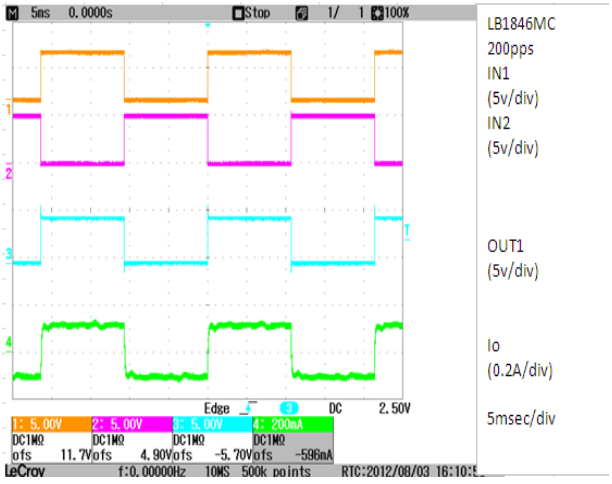


- Connect a stepping motor with OUT1, OUT2, OUT3 and OUT4.
- Connect the motor power supply with the terminal VCC, the control power supply with the terminal VIN. Connect the GND line with the terminal GND.
- STP motor drives it in a Full-Step, Half-Step by inputting a signal such as follows into IN1~IN4.
- For input signal to function generator, refer to p.8.
  To reverse motor rotation, make sure to input signal to outward direction.

Waveform of LB1948MC evaluation board when driving stepping motor

- Full-Step Drive

LB1846MC Full-Step (VCC=12V, 200pps)



LB1846MC Half-Step (VCC=12V, 200pps)